





Select Industrial Automation Partner

# **3S Series 3D sensors**

High-resolution, high-speed 3D sensors for static and dynamic dimensioning and inspection applications

Zebra\_3S-CFP-UMD.001

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Today's Machine Vision Challenges

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# Beyond the Limits of 2D Machine Vision Some inspection applications cannot be efficiently addressed with 2D machine vision



Applications with little to no contrast or reflective materials



Challenging to illuminate with conventional machine vision lighting





Dimensioning or measuring volume and flatness



Measuring angles in post assembly inspection



Object of interest vibrating or bouncing around on a conveyor







3D Machine Vision Solution Challenges Implementing 3D machine vision in manufacturing and logistics inspection applications presents several challenges:

**3D Data Complexity**: 3D imaging generates a large amount of data, which can be complex to process and analyze. This complexity can lead to increased computational requirements and longer processing times.

#### Training and Expertise:

Implementing and maintaining 3D vision systems requires a certain level of expertise. There may be a lack of skilled personnel who can handle these systems effectively. **Operating Speed**: In highspeed manufacturing and logistics environments, 3D vision systems must capture and process data quickly. However, the high data volume and complexity of 3D vision can make it challenging to meet speed requirements.

#### Integration with Existing Systems and Cost: 3D

vision systems can be challenging to integrate with existing workflows and can be expensive to implement and maintain. **Lighting Conditions**: The accuracy of 3D vision systems can be significantly affected by lighting conditions. Achieving consistent lighting can be challenging, especially in large-scale industrial environments.



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# Increase manufacturing productivity and logistical throughput 3S Series 3D sensors help manufacturers improve:



Quality control



Robotic guidance

Production efficiency



Violds and reduce waste	





Automation

#### 3S80-4M

## Medium Field of View for High-Speed Acquisition

Unsurpassed 3D resolution and accuracy for capturing dynamic and static scenes

#### Parallel Structured light: Patented light sensor for dynamic and static scenes

Fast acquisition of 3D data: Up to 2 million 3D points (1680 x 1200) in a 45 ms scan

Shorter cycles times: Faster bin picking with shorter cycle times Large scanning range: 19.6 - 37 in / 497–939 mm to capture objects large and small

#### **Plug-and-play integration:** Just point the 3S80-4M at a scene to capture an accurate high-density point cloud



3S80-4M Field of View

### 3S80-4L

## Large Field of View for High-Speed Acquisition

Unsurpassed 3D resolution and accuracy for capturing dynamic and static scenes

Parallel Structured light: Patented light sensor for dynamic and static scenes Fast acquisition of 3D data: Up to 2 million 3D points (1680 x 1200) in a 45 ms

Shorter cycles times: Faster bin picking with shorter cycle times Large scanning range: 30.6 - 119.4 in / 778 - 3,034 mm to capture objects large and small

**Plug-and-play integration:** Just point the 3S80-4L at a scene to capture an accurate high-density point cloud



High-resolution 3D imaging for static dimensioning, inspection and depalletization applications

**Structured light:** Sequential structured light sensor for static scenes

Ambient Light Suppression: 1.5Mpix scanning with laser projection and ambient light suppression

3S40 Field of View

Large Scanning range: 34.3 x 88.5 in /870–2150 mm to capture objects large and small

**Plug-and-play integration:** Just point the 3S40 at a scene to capture an accurate high-density point cloud

### **3S Series**

#### **Available Solution Bundles**

Pairs with Zebra Aurora<sup>™</sup> software and the EV7 vision controller for optimized 3D performance

Bundled with Aurora Design Assistant or Aurora Vision Studio software

Optional Bundles Include Zebra 4Sight EV7 vision controller



Zebra **Aurora** Design Assistant<sup>™</sup>



4Sight EV7

Zebra **Aurora Vision** Studio<sup>™</sup>

## What Can Zebra Do in 3D Vision? 3D tools in Zebra Aurora

- 3D surface matcher
  - From point cloud or CAD (PLY or STL)



ModelFinder3D step

- 3D BoxFinder
  - Returns position, orientation and dimensions







#### 3D tools in Zebra Aurora

- 3D analysis and processing
  - Profile extraction
  - Volume measurement
  - Plane fit
  - Gap filling
  - Subsample
  - Mesh
  - Resample







AlignPlane step

## What Can Zebra Do in 3D Vision? Deep learning to further enhance solution quality

- Aurora Vision Studio Add On
  - Quickly design and deploy deep learning-based solutions
  - Graphical model training environment
- Learns from just a few samples
  - Typical applications require from 20-50 training images
  - OCR, Feature detection, Anomaly detection, and Classification
- Runs very fast on GPU and CPU
  - GPU required for training (Typical training time is 5-15 minutes)
  - Runs on GPU and CPU (GPU typically 3-10x faster)
  - Inference time varies depending on the tool and hardware (between 5 and 100 ms per image)



**Benefits of 3D Vision Technology** 

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## Benefits of 3D Vision Technology Point Cloud



3D representation of a scene, where each point has X,Y, and Z coordinates

Can be moved around in 3D view

- Right click to pan
- Left click to rotate

The color of the points is based on the Texture Source (Color, Focus, LED, etc.) Measuring angles in post assembly inspection



# Structured Light Technology



#### **Basic principle**

- Structured Light Technology is a triangulation technique
  - Laser / Object / Camera
- Light patterns are projected onto the object by the laser
- The stripes of light get distorted as they hit the object
- The object reflects the distorted light back to the camera
- By combining the information from the patterns with the known relative positions of the laser and camera, we can calculate the 3D position of the object



Methodologies and Techniques for Reverse Engineering–The Potential for Automation with 3-D Laser Scanners - Scientific Figure on ResearchGate.

# Structured Light Technology



Sequential structured light (3S40)

- One laser sweep per projected pattern
- The patterns are created by turning off the laser periodically



# Structured Light Technology Sequential structured light (3S40)

• Image sensor exposure:



- Resulting images:
  - Each pixel has information about all the patterns

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P1	Pt	I F	21	P1	P1	P1	P1	P1	P1	P2	P2	P2	P2	P2	P2	P2	P2	P2	P5	P5	P5	P5	P5	P5	P5	P5	P5
P1	PI	F	21	P1	P1	P1	P1	P1	P1	P2	P2	P2	P2	P2	P2	P2	P2	P2	P5	P5	P5	P5	P5	P5	P5	P5	P5
P1	P1	F	71	P1	P1	P1	P1	P1	P1	P2	P2	P2	P2	P2	P2	P2	P2	P2	P5	P5	P5	P5	P5	P5	P5	P5	P5
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P1	P1	F	21	P1	P1	P1	P1	PI	P1	P2	P2	P2	P2	P2	P2	P2	P2	P2	P5	P5	P5	P5	P5	P5	P5	P5	P5
P1	Pt	F	21	P1	P1	P1	P1	P1	P1	P2	P2	P2	P2	P2	P2	P2	P2	P2	P5	P5	P5	P5	P5	P5	P5	P5	P5
P1	P	F	21	P1	P1	P1	P1	P1	P1	P2	P2	P2	P2	P2	P2	P2	P2	P2	P5	P5	P5	P5	P5	P5	P5	P5	P5
P1	PI	P	21	P1	P1	P1	P1	P1	P1	P2	P2	P2	P2	P2	P2	P2	P2	P2	P5	P5	P5	P5	P5	P5	P5	P5	P5

# Structured Light Technology

Parallel structured light (3S80)

- The laser is on during the whole sweep
- Pixels are "turned off" individually at the sensor level to create multiple patterns in one sweep
- Each pixel has information about 1 pattern only
- The data is interpolated to compensate for the missing information









# Sequential vs. Parallel Structured Light – Raw data 3S40 vs 3S80





# Sequential vs. Parallel Structured Light – Resulting point cloud 3S40 vs 3S80







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# **3D Applications** Transport & Logistics



- Volume measurement
- Pick and place
- Box dimensioning
- Defect detection



#### Palletizing/Depalletizing

Efficiently palletize and depalletize items of various sizes

Efficiently palletize and depalletize various size bags, boxes, totes and other items. Identify tightly stacked bags with slight deformations

Optimize stacking and support universal pallet patterns Reduce cycle times to even the most aggressive requirements using fast acquisition



#### **Object Dimensioning**

Measure object width, length and height (or bounding box)

Each object on the conveyor is 3D modeled by two synchronized 3D sensors Fast acquisition with best data quality-to-speed ratio

High-speed precision dimensioning of both regular and irregularly shaped items Improve the density of storage and effectively sort products



Estimate shipping costs more accurately

#### **Box Dimensioning**

Consistent, real-time scanning of box dimensions in rapid motion

High-resolution, highaccuracy volume measurement at speeds up to 40 m/sec

Bounding box estimation

Sorting

Counting

**Deformation detection** 





#### **Mixed-SKU Piece Picking**

Pick items from a source bin and place/drop them in a destination bin

Perform pick tasks precisely, accurately, and reliably without breaks due to fatigue, monotony and environmental distractions Reduce labor costs by automating repetitive and tedious tasks, as well as heavy lifting

Streamline warehouse and supply chain operations by automating pick, pack and transport tasks Reduce cycle times to even the most aggressive requirements using fast acquisition





Reduce the risk of errors using robotic order fulfillment

#### Pick and Place, Pick and Drop and Robotic Sortation

Ensure optimal robotic placement of products:

Maintain a strict minimum of empty space in individual parcels Separate, identify and sort

Optimize logistics processes within the company, for example, stock densification Speed up deliveries and lower shipping costs

Precisely assemble several products in a package

Automotive manufacturers rely heavily on bead inspection

Ensure the presence of the adhesive bead

Efficiently detect bead overfill, underfill, continuity and gaps

Measure correct quantity and location



#### **Defect Detection**

#### Inspection and quality control of large metal parts in motion

Inspect large metal parts moving on a conveyor

Reduce cycle times to even the most aggressive requirements using fast acquisition

Check small details inside the sheets, such as holes and cuts, for accuracy with up to 2-megapixel resolution Scan large objects such as metal sheets and B-pillars



Tolerates random object movements or vibrations on the conveyor

#### **Defect Detection**

#### Identify defects and anomalies in an object's surface

Check that all components have been assembled correctly

Accurately measure height, width, texture and other characteristics

Detect minor surface variations, including dents, scratches and other irregularities Check for paint runs, sags and bubbles that could affect the paint's appearance or durability



Detect minute variations in the surface of car parts

Check that all components are installed correctly and that no unwanted elements exist

Ensure that doors, hoods, and trunks are aligned properly and that gaps are not excessive Inspect the quality and presence of seals in components such as doors and windows

Verify the presence of screws, clips, fasteners and other critical components Make sure welds are present where they are needed and absent where they are not



Measure the position and gap between components

#### Electronics

### PC Assembly

Assembling PC motherboards involves precisely positioning various electronic components on a printed circuit board (PCB)

Precisely assemble various electronics components such as memory modules, CPUs and heatsinks Quickly switch between different board variants to meet specific customer requirements

Locate a wide range of components, from tiny resistors to larger integrated circuits Assemble motherboards into PC chassis and housing





#### Speed

#### Simplicity, Flexibility, Longevity, Value

What makes our 3D sensor portfolio different?

Program easily for simple implementation and sophisticated performance Leverage an extensive library of tools

Deploy faster, solve applications quicker

Capture dynamic scenes with unsurpassed 3D resolution and accuracy

Minimize or eliminate training



# Tackle More 3D Applications With Both Zebra Offerings

Solve the most challenging applications with 3D sensing solutions from Zebra

#### AltiZ

- Applications requiring high resolution and high accuracy
- Inspection of small features
  - Surface inspection
  - Precise measurement
- Application with continuous movement
  - For example conveyor belt with encoder



#### **3S Series**

- Easy to set up
  - No encoder required
  - No hardware trigger
- Static scenes
- Dynamic scenes
  - Arbitrary movement
  - Vibration



**Product Specifications** 

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3540

## **3S40 Specifications**





	3S40-4L
3D sensing technology	Structured light
Scanning range	34.3 x 88.5 in /870–2150 mm
Maximum scan rate	2 fps
Scanning time	from 450 ms
Point size	0.82 mm @z = 1245 mm
Accuracy	< 0.50 mm

## **3S80 Specifications**







	3S80-4M	3S80-4L					
3D Sensing Technology	Parallel Structured Light	Parallel Structured Light					
Scanning range	19.6 – 37 in / 497–939 mm	30.6 – 119.4 in / 778 – 3,034 mm					
Maximum scan rate	20 fps	20 fps					
Scanning time	10 ms	20 ms					
Dynamic mode							
Point size	0.55 mm @z = 650 mm	1.05 mm @z = 1239 mm					
Accuracy	< 0.500 mm	< 1.250 mm					
Static mode							
Point size	0.37 mm @z = 650 mm	0.72 mm @z = 1239 mm					
Accuracy	< 0.250 mm	< 0.900 mm					

# UMD Value Add





#### **UMD** Value Add

#### **Engineering IoT Solutions**

### 🎝 Design

#### **Design & manufacture:**

- IoT devices and interfaces
- Cables
- Modify products
- Mechanical design and assemble

#### Support

Through our extensive professional services in

- Engineering
- Software
- Deployment
- Support

# X Source

- Data capture & ICT products and from our many agencies
- Systems Integration
- Solutions Architecture
- Systems Engineering



#### Encompassing

- Data Carriers (barcode, RFID, sensors)
- Edge devices and gateways
- Own and manage PCI-DSS compliant Data Center
- Middleware and Cloud Application Broker
- Software: cloud, mobile and embedded applications
- Design, deploy and managed services



# Thank you!

For more information, visit, <u>www.zebra.com/3s-series</u>



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